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# TRANSMITTAL FORM

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Total Number of Pages in This Submission

10

Application Number

10/750,387

Filing Date

12/31/03

First Named Inventor

KRONZER

Art Unit

1774

Examiner Name

B. SHEWAREGED

Attorney Docket Number

N-19608

## ENCLOSURES (Check all that apply)

☐

Fee Transmittal Form

☐

Fee Attached

☒

Amendment/Reply

☐

After Final

☐

Affidavits/declaration(s)

☐

Extension of Time Request

☐

Express Abandonment Request

☐

Information Disclosure Statement

☐

Certified Copy of Priority Document(s)

☐

Reply to Missing Parts/  
Incomplete Application

☐

Reply to Missing Parts  
under 37 CFR 1.52 or 1.53

☐

Drawing(s)

☐

Licensing-related Papers

☐

Petition

☐

Petition to Convert to a  
Provisional Application

☐

Power of Attorney, Revocation

☐

Change of Correspondence Address

☐

Terminal Disclaimer

☐

Request for Refund

☐

CD, Number of CD(s) \_\_\_\_\_

☐

Landscape Table on CD

☐

After Allowance Communication to TC

☐

Appeal Communication to Board  
of Appeals and Interferences

☐

Appeal Communication to TC  
(Appeal Notice, Brief, Reply Brief)

☐

Proprietary Information

☐

Status Letter

☐

Other Enclosure(s) (please identify  
below):

Remarks

## SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

Firm Name

NEENAH PAPER, INC.

Signature

*William D. Herrick*

Printed name

William D. Herrick

Date

19-Sept-06

Reg. No.

25468

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Typed or printed name

William D. Herrick

Date

19-Sept-06

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Appln. No. 10/750,387

Reply to Office Action Mailed 20-Jun-06

**In the United States Patent and Trademark Office**

Applicant:	Kronzer	Docket No.:	N-19608
Serial No.:	10/750,387	Group:	1774
Filed:	12/31/03	Examiner:	B. Shewareged
For:	Heat Transfer Material	Date:	19-Sept-06

COMMISSIONER FOR PATENTS

PO Box 1450

Alexandria, Virginia 22313-1450

**RESPONSE TO NON-FINAL REJECTION**

Sir:

Pursuant to 37 C.F.R. 1.111 and in response to the Office Action mailed 20-Jun-06,

Applicant respectfully submits this Response including the following remarks for consideration.

A listing of claims reflecting current status begins on page 2.

Remarks/Argument begins on page 7.

**CERTIFICATE OF MAILING**

I, William D. Herrick, hereby certify that on 19-Sept-06 this document is being deposited with the United States Postal Service as first-class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, Virginia 22313-1450.

By:

William D. Herrick